

YJ Planar Schottky Barrier Diode Die Specification

60V 1A, 32mil, Schottky barrier diode die based on silicon planar process
Part No.: PSB032M060SS-280A

Main Products Characterstics

Maximum Ratings			Static Electrical Characteristics (Ta = 25°C)			
Parameter	Symbol	Rating	Parameter	Symbol	Value	
					Spec	Typical
Repetitive peak reverse voltage	V _{RRM}	60 V	Reverse breakdown voltage	V _{BR}	65V	72V
Average forward current	I _{F(AV)}	1 A	I _R = 1mA			
(tp = 8.3 ms, halfwave, 1 cycle)	I _{FSM}	30 A	Maximum forward voltage drop	V _F	0.65V	0.60V
			I _F = 1 A			
Storage temperature range	T _{stg}	-50 to +150 °C	≤ 2%			
Maximum operating junction temperature	T _j	150 °C	Maximum reverse current	I _R	50uA	5uA
			V _R = V _{RRM}			
			≤ 2%			

Device Schematics and Outline Drawing

Die Thickness *	11 Mils
Die Size **	32.7 Mils
Top Metal Pad	28.7 Mils
Active Area	24.8 Mils
Top Metal	Ag
Back Metal	Ag
Note: 1 * : Also can offer device with 8 mils thickness	
2 **: Cutting street width is around 1.5 mils	

Important Notice

Specification apply to die only. Actual performance may degrade when assembled.	Recommended Storage Environment:
does not guarantee device performance after assembly.	Store in original container, in dessicated nitrogen, with no contamination.
All operating parameters must be validated for each customer application by customer's technical experts.	Shelf life for parts stored in above condition is 2 years.
Data sheet information is subjected to change without notice.	If the storage is done in normal atmosphere shelf life is reduced to 6 months.